COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a
patent is sought on the invention entitled <u>FABRICATION OF DRAM AND OTHER SEMICONDUCTOR</u>
DEVICES WITH AN INSULATING FILM USING A WET RAPID THERMAL OXIDATION PROCESS, the
specification of which
in attached berato
was filed on as Application Serial No
and was amended on was described and claimed in PCT International Application No filed on and was amended under PCT Article 19 on
was described and claimed in PCT International Application No.
filed on and as amended under PCT Article 19 on
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.
I acknowledge the duty to disclose all information I know to be material to patentability in accordance with Title 37, Code of Federal Regulations, §1.56.
I hereby appoint the following attorneys and/or agents to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith: Michael L. Lynch, Reg. No. 30,871; Lia M. Pappas, Reg. No. 34,095; W. Eric Webostad, Reg. No. 35,406; Charles B. Brantley II, Reg. No. 38,086; Samuel Borodach, Reg. No. 38,388; Victor Siber, Reg. No. 27149; Stephan J. Filipek, Reg. No. 33,384; John B. Pegram, Reg. No. 25,198; William J. Hone, Reg. No. 26,739; Frederick H. Rabin, Reg. No. 24,488; Richard P. Ferrara, Reg. No. 30,632; Gabriel P. Kralik, Reg. No. 34,855; Andrew T. D'Amico, Reg. No. 33,375; Andrew N. Parfomak, Reg. No. 32,431.
Address all telephone calls to Samuel Borodach at telephone number 212/765-5070.
Address all correspondence to Victor Siber, Fish & Richardson P.C., 45 Rockefeller Plaza, New York, NY 10111.
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.
Full Name of Inventor: Ronald A. Weimer
Inventor's Signature: Parit a Wein Date: 17 apr. 1 1999
Residence Address: 1696 E. Victory Road, Boise, Idaho 83706
Citizen of: U.S.A.
Post Office Address: 1696 E. Victory Road, Boise, Idaho 83706

COMBINED DL LARATION AND POWER OF AT LORNEY CONTINUED

Full Name of Inventor: Scott J. DeBoen	
Inventor's Signature:	Date: 4/15/99
Residence Address: 259 E. Twin Willow, Boise, Idaho 83706	
Citizen of: U.S.A.	
Post Office Address: 259 E. Twin Willow, Boise, Idaho 83706	
Full Name of Inventor: Dan Gealy	
Inventor's Signature:	_ Date: <u>4/15/5</u> S
Residence Address: 4300 Junayo Ln, Kuna, Idaho 83634	
Citizen of: U.S.A.	
Post Office Address: 4300 Junayo Ln, Kuna, Idaho 83634	
Full Name of Inventor: Husam N. Al-Shareef	
Inventor's Signature:	Date:
Residence Address: 2856 W. Cherry Lane, Boise, Idaho 83704	
Citizen of: U.S.A.	
Post Office Address: 2856 W. Cherry Lane, Boise, Idaho 83704	

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COMBINED DE LARATION AND POWER OF AT. JRNEY CONTINUED

Full Name of Inventor: Scott J. DeBoer	
Inventor's Signature:	Date:
Residence Address: 259 E. Twin Wıllow, Boise, Idaho 83706	
Citizen of: U.S.A.	
Post Office Address: 259 E. Twin Willow, Boise, Idaho 83706	
Full Name of Inventor: Dan Gealy	
Inventor's Signature:	Date:
Residence Address: 4300 Junayo Ln. Kuna, Idaho 83634	
Citizen of: U.S.A.	
Post Office Address: 4300 Junayo Ln. Kuna, Idaho 83634	
Full Name of Inventor: Husam N. Al-Shareef	
Inventor's Signature: Hasam AlShace A	Date: 5/17/99
Residence Address: Muraijeb, Al-Ain, United Arab Emirates	
Citizen of: U.S.A.	
Post Office Address: <u>UAE University</u> , Department of Physics, P.O.	
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44799.N11

PATENT

Docket No.: M4065.0319/P319

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Ronald Weimer et al.

Serial No.: 09/296,835

Group Art Unit: 2813

Filed: April 22, 1999

Examiner: Not Yet Assigned

For: FABRICATION OF DRAM AND OTHER SEMICONDUCTOR DEVICES WITH AN INSULATING FILM USING A WET RAPID THERMAL OXIDATION PROCESS

Assistant Commissioner for Patents Washington, D.C. 20231

POWER OF ATTORNEY BY ASSIGNEE AND CERTIFICATE BY ASSIGNEE UNDER 37 CFR § 3.73(b)

Micron Technology, Inc., Assignee of the entire right, title and interest in the above-identified application by virtue of the Assignment, a copy of which is attached hereto, hereby appoints the attorneys and agents of the firm of Dickstein, Shapiro, Morin & Oshinsky, listed as follows: Gary M. Hoffman, 26,411; Thomas J. D'Amico, 28,371; Donald A. Gregory, 28,954; James W. Brady Jr., 32,115; Jon D. Grossman, 32,699; Mark J. Thronson, 33,082; Jeremy A. Cubert, 40,399; Laurence E. Fisher, 37,131; Brian A. Lemm, 43,748; Gianni Minutoli, 41,198; Edwin Oh, P-45,319; Eric Oliver, 35,307; William E. Powell III, 39,803; Paul L. Ratcliffe, 45,290; Mark E. Strickland, 45,138 and Salvatore P. Tamburo, 45,153, and also attorneys of Micron Technology, Inc. as its

attorneys with full power of substitution to prosecute this application and to transact all business in the Patent and Trademark Office in connection therewith.

The Assignee certifies that the above-identified assignment has been reviewed and to the best of the Assignee's knowledge and belief, title is in the assignee.

Please direct all correspondence regarding this application to the following:

Thomas J. D'Amico Dickstein Shapiro Morin & Oshinsky LLP 2101 L Street NW

Telephone: (202) 785-9700 Fax: (202) 887-0689

MICRON TECHNOLOGY, INC.

Michael L. Lynch Chief Patent Counsel Registration No. 30,871

Dated: 011, 2000

ASSIGNMENT



For valuable consideration, We, Ronald A. Weimer of 1696 E. Victory Road, Boise, Idaho 83706, Scott J. DeBoer of 259 E. Twin Willow, Boise, Idaho 83706, Dan Gealy of 4300 Junayo Ln, Kuna, Idaho 83634 and Husam N. Al-Shareef of 2856 W. Cherry Lane, Boise, Idaho 83704 hereby assign to Micron Technology, Inc., a Delaware corporation having a place of business at 8000 S. Federal Way, Boise, Idaho 83706-9632, and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us, entitled

FABRICATION OF DRAM AND OTHER SEMICONDUCTOR DEVICES WITH AN INSULATING FILM USING A WET RAPID THERMAL OXIDATION PROCESS

filed on April 22, 1999 and assigned U.S. Serial Number 09/296,835, and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models and design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request effectuate fully this assignment.	d s,
IN WITNESS WHEREOF I hereto set my hand and seal at	
this 14 day of April , 1998	
	L.S
Ronald A. Weimer	
STATE OF:	
COUNTY OF: ss.	
Before me this 14th day of 1991, personally appeared Ronald A. Weimer, known to me to be the person whose name is subscribed to the foregoing Assignment and acknowledged that he executed the same as his free act and deed for the purposes therein contained.	ıt,
Notary Public	
My Commission Expires: 3-36-03	

IN WITNESS WHEREOF, I hereto Let my hand and seal at Boise, Ia. o	,
this 15th day of April 1998 Scott J. DeBoer	S .
STATE OF IDAHO::ss.	
COUNTY OF ADA :	
Before me this	and
Notary Public Notary Public My Commission Expires: 3/12/2002 [Notary Public My Commission Expires: 3/12/2002	
IN WITNESS WHEREOF, I hereto set my hand and seal at Boise, Johnson	 ,
this 15th day of April , 1998	. a.
Dan Gealy	L.S.
STATE OF TOPHO::ss.	
COUNTY OF ADA:	
Before me this, day of, 1996, personally appeared Dan Gealy, known to me to be the person whose name is subscribed to the foregoing Assignment, and acknowledged that he executed the same as his free ast and deed for the purposes therein contained.	
Notary Public Notary Public	
My Commission Expires: 3/12/2002 [Notary's Seal He of OF IDAM.	
Of the state of th	

ASSIGNMENT

For valuable consideration, I, Husam N. Al-Shareef of Muraijeb, Al-Ain, United Arab Emirates, hereby assign to Micron Technology, Inc., a Delaware corporation having a place of business at 8000 S. Federal Way, Boise, Idaho 83706-9632, and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by me, entitled

FABRICATION OF DRAM AND OTHER SEMICONDUCTOR DEVICES WITH AN INSULATING FILM USING A WET RAPID THERMAL OXIDATION PROCESS

filed on April 22, 1999 and assigned U.S. Serial Number 09/296, \$35, and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting about the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granter for any of said inventions or improvements, and the right to claim priority based on the filing date of sa application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in my name or in its own name for patents, utility model and design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and I agree for myself and my heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminar Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.	od aid als, d
In Witness Whereof, I hereto set my hand and seal at Al-Ain, United Arab Santales	2
this (7 day of May, 1999	
this 17 day of May, 1999 Husam AlShareef Husam N. Al-Shareef	L.S.
Witness:	
Date: $5 \sim 17 - 99$	